

R1LV0108E Series

1Mb Advanced LPSRAM (128k word x 8bit)

R10DS0152EJ0100 Rev.1.00 2013.6.21

Description

The R1LV0108E Series is a family of low voltage 1-Mbit static RAMs organized as 131,072-word by 8-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LV0108E Series has realized higher density, higher performance and low power consumption. The R1LV0108E Series is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. It has been packaged in 32-pin SOP,32-pin TSOP and 32-pin sTSOP.

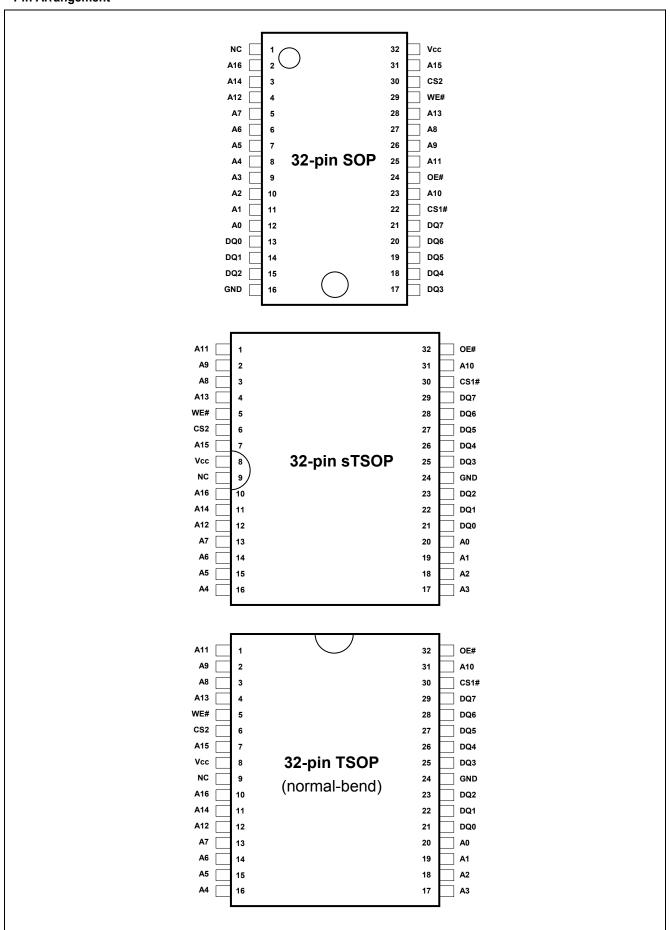
Features

- Single 2.7~3.6V power supply
- Small stand-by current: 0.6µA (3.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS1# and CS2
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus

Ordering Information

Orderable Part Name	Access time	Temperature Range	Package	Shipping Container	Quantity		
R1LV0108ESN-5SR#B*	FF 72	0 ~ +70°C					
R1LV0108ESN-5SI#B*	55 ns	-40 ~ +85°C		Tuk -	Max. 25pcs/Tube		
R1LV0108ESN-7SR#B*	70	0 ~ +70°C	525-mil 32-pin	Tube	Max. 225pcs/Inner Bag Max. 900pcs/Inner Box		
R1LV0108ESN-7SI#B*	70 ns	-40 ~ +85°C	plastic SOP				
R1LV0108ESN-5SR#S*	EE no	0 ~ +70°C	PRSP0032DF-A				
R1LV0108ESN-5SI#S*	55 ns	-40 ~ +85°C	(32P2S-A)	Embossed	4000mm/Dagl		
R1LV0108ESN-7SR#S*	70 ns	0 ~ +70°C		tape	1000pcs/Reel		
R1LV0108ESN-7SI#S*	70118	-40 ~ +85°C					
R1LV0108ESA-5SR#B*	EE no	0 ~ +70°C					
R1LV0108ESA-5SI#B*	55 ns	-40 ~ +85°C		Trov	Max. 234pcs/Tray		
R1LV0108ESA-7SR#B*	70 ns	0 ~ +70°C	8mm×13.4mm 32-pin plastic sTSOP	Tray	Max. 1872pcs/Inner Box		
R1LV0108ESA-7SI#B*	70118	-40 ~ +85°C	(normal-bend type)				
R1LV0108ESA-5SR#S*	55 ns	0 ~ +70°C		Embossed			
R1LV0108ESA-5SI#S*	55118	-40 ~ +85°C	PTSA0032KB-A (32P3K-B)		Embossed	Embossed	Embossed
R1LV0108ESA-7SR#S*	70	0 ~ +70°C	(02) (0.(2)	tape	1000pcs/Reel		
R1LV0108ESA-7SI#S*	70 ns	-40 ~ +85°C					
R1LV0108ESF-5SR#B*	55 ns	0 ~ +70°C					
R1LV0108ESF-5SI#B*	22 118	-40 ~ +85°C		Trov	Max. 156pcs/Tray		
R1LV0108ESF-7SR#B*	70	0 ~ +70°C	8mm×20mm 32-pin plastic TSOP	Tray	Max. 1248pcs/Inner Box		
R1LV0108ESF-7SI#B*	70 ns	-40 ~ +85°C	(normal-bend type)				
R1LV0108ESF-5SR#S*	55.55	0 ~ +70°C					
R1LV0108ESF-5SI#S*	55 ns	-40 ~ +85°C	PTSA0032KA-A (32P3H-E)	Embossed	1000non/Dool		
R1LV0108ESF-7SR#S*	70 ps	0 ~ +70°C	(02: 011 2)	tape	1000pcs/Reel		
R1LV0108ESF-7SI#S*	70 ns	-40 ~ +85°C					

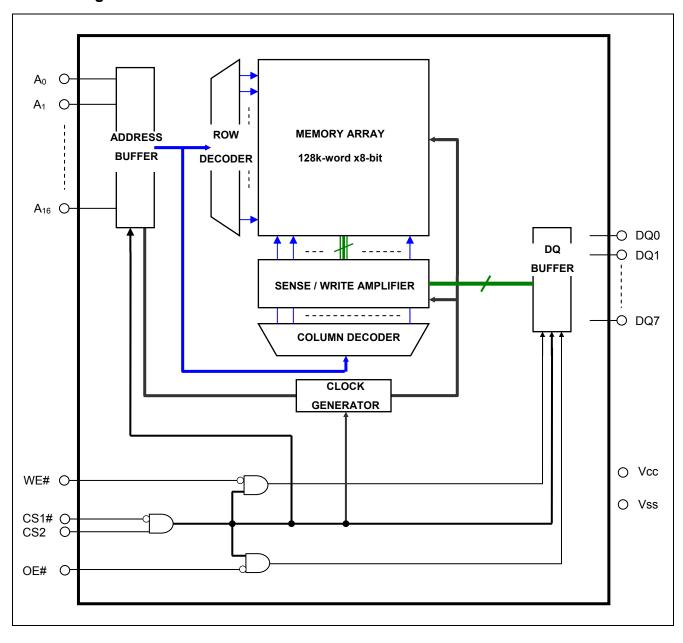
Pin Arrangement



Pin Description

Pin name	Function
Vcc	Power supply
Vss	Ground
A0 to A16	Address input
DQ0 to DQ7	Data input/output
CS1#	Chip select 1
CS2	Chip select 2
WE#	Write enable
OE#	Output enable
NC	Non connection

Block Diagram



Operation Table

CS1#	CS2	WE#	OE#	DQ0~7	Operation
Х	L	Х	Х	High-Z	Stand-by
Н	Х	Х	Х	High-Z	Stand-by
L	Н	L	Х	Din	Write
L	Н	Н	L	Dout	Read
L	Н	Н	Н	High-Z	Output disable

Note 1. H: V_{IH} L: V_{IL} X: V_{IH} or V_{IL}

Absolute Maximum

Parameter	Symbol	Va	lue	unit	
Power supply voltage relative to Vss	Vcc	-0.3 to	0 +4.6	V	
Terminal voltage on any pin relative to Vss	V _T	-0.3 ^{*1} to	-0.3*1 to Vcc+0.3*2		
Power dissipation	P _T 0.7		.7	W	
Operation temperature	Topr*3	R Ver.	0 to +70	°C	
Operation temperature	ТОРГ	I Ver.	-40 to +85	C	
Storage temperature range	Tstg	-65 t	-65 to 150		
Storage temperature range under him	Tbias*3	R Ver.	0 to +70	°C	
Storage temperature range under bias	Iblas	I Ver.	-40 to +85		

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

- 2. Maximum voltage is +4.6V.
- 3. Ambient temperature range depends on R/I-version. Please see table on page 1.

DC Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Supply voltage	Supply voltage		2.7	3.0	3.6	V	
		Vss	0	0	0	V	
Input high voltage	Input high voltage		2.0	-	Vcc+0.3	V	
Input low voltage		V_{IL}	-0.3	-	0.6	V	1
Ambient temperature range	R Ver.		0	-	+70	°C	2
Ambient temperature range	I Ver.	Та	-40	-	+85	°C	2

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

2. Ambient temperature range depends on R/I-version. Please see table on page 1.

DC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions		
Input leakage current	I _{LI}	-	-	1	μΑ	Vin = Vss t	to Vcc	
Output leakage current						CS1# =V _{IH}	or CS2 =V _{IL} or	
	I _{LO}	-	-	1	μΑ	OE# =V _{IH} ,		
						VI/O =Vss	to Vcc	
Average operating current	I _{CC1}		15	25	mA	Min. cycle,	duty =100%, II/O = 0mA	
	ICC1		10	20	ША	CS1# =V _{IL}	, CS2 =V _{IH} , Others = V _{IH} /V _{IL}	
						Cycle =1µs	s, duty =100%, II/O = 0mA	
	I _{CC2}	-	2	5	mA		2V, CS2 ≥ Vcc-0.2V,	
							0.2V, V _{IL} ≤ 0.2V	
Standby current						"CS2 =V _{IL} "		
	I _{SB}	-	-	0.33	mA		and CS1# =V _{IH} ",	
						Others = V	ss to Vcc	
Standby current		-	0.6*1	2	μА	~+25°C	Vin = Vss to Vcc	
	,	-	-	3	μА	~+40°C	(1) CS2 ≤ 0.2V or (2) CS1#≥ Vcc-0.2V,	
	I _{SB1}	-	-	8	μА	~+70°C	(2) CS1# ≥ VCC-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μА	~+85°C		
Output high voltage	V _{OH}	2.4	-	-	V	I _{OH} = -0.5m	nA	
	V _{OH2}	Vcc - 0.5		-	V	I _{OH} = -0.05	mA	
Output low voltage	V _{OL}	-	-	0.4	V	I _{OL} = 2mA		

Note $\,$ 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

Capacitance

 $(Vcc = 2.7V \sim 3.6V, f = 1MHz, Ta = 0 \sim +70^{\circ}C / -40 \sim +85^{\circ}C^{*2})$

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	8	pF	Vin =0V	1
Input / output capacitance	C _{I/O}	-	-	10	pF	VI/O =0V	1

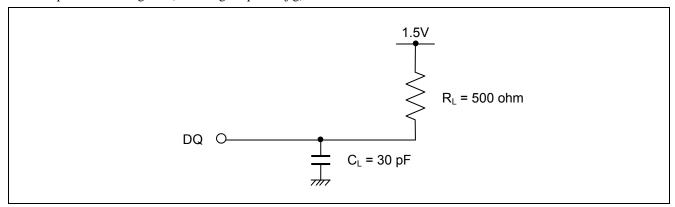
Note 1. This parameter is sampled and not 100% tested.

2. Ambient temperature range depends on R/I-version. Please see table on page 1.

AC Characteristics

Test Conditions (Vcc = 2.7V ~ 3.6V, Ta = $0 \sim +70^{\circ}\text{C} / -40 \sim +85^{\circ}\text{C}^{*1}$)

- Input pulse levels: VIL = 0.4V, VIH = 2.2V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)



Note 1. Ambient temperature range depends on R/I-version. Please see table on page 1.

Read Cycle

Parameter	Symbol	R1LV010	08E**-5**	R1LV010)8E**-7**	Unit	Note
Farameter	Symbol	Min.	Max.	Min.	Max.	Offic	Note
Read cycle time	t _{RC}	55	-	70	i	ns	
Address access time	t _{AA}	1	55	-	70	ns	
Chin calcat aggest time	t _{ACS1}	1	55	-	70	ns	
Chip select access time	t _{ACS2}	1	55	-	70	ns	
Output enable to output valid	toE	-	30	-	35	ns	
Output hold from address change	tон	5	-	10	-	ns	
Chin coloct to output in low 7	t _{CLZ1}	5	-	10	i	ns	2,3
Chip select to output in low-Z	t _{CLZ2}	5	-	10	-	ns	2,3
Output enable to output in low-Z	t _{OLZ}	5	-	5	-	ns	2,3
Chin deceled to autout in high 7	t _{CHZ1}	0	20	0	25	ns	1,2,3
Chip deselect to output in high-Z	t _{CHZ2}	0	20	0	25	ns	1,2,3
Output disable to output in high-Z	t _{OHZ}	0	20	0	25	ns	1,2,3

Write Cycle

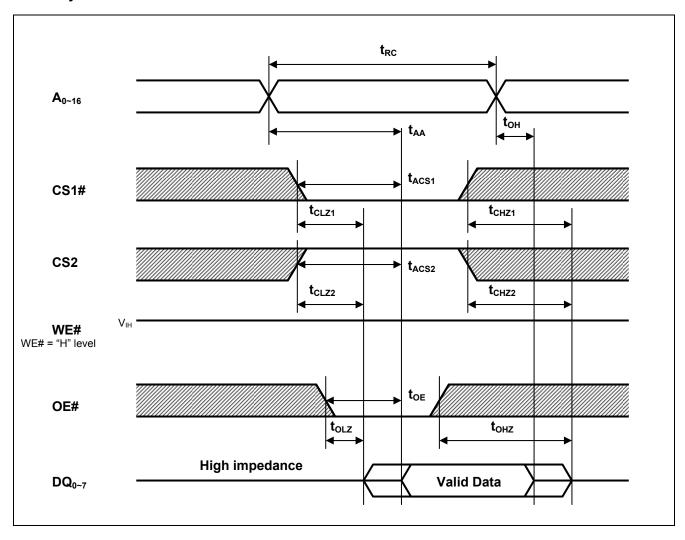
Darameter	Cymhol	R1LV010)8E**-5**	R1LV010	08E**-7**	Linit	Note
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	Note
Write cycle time	twc	55	-	70	-	ns	
Address valid to end of write	t _{AW}	50	-	55	-	ns	
Chip select to end of write	t _{CW}	50	-	55	-	ns	5
Write pulse width	t _{WP}	45	-	50	-	ns	4
Address setup time	t _{AS}	0	-	0	-	ns	6
Write recovery time	t _{WR}	0	-	0	-	ns	7
Data to write time overlap	t _{DW}	25	-	30	-	ns	
Data hold from write time	t _{DH}	0	-	0	-	ns	
Output enable from end of write	tow	5	-	5	-	ns	2
Output disable to output in high-Z t _{OHZ}		0	20	0	25	ns	1,2
Write to output in high-Z	t _{WHZ}	0	20	0	25	ns	1,2

Note

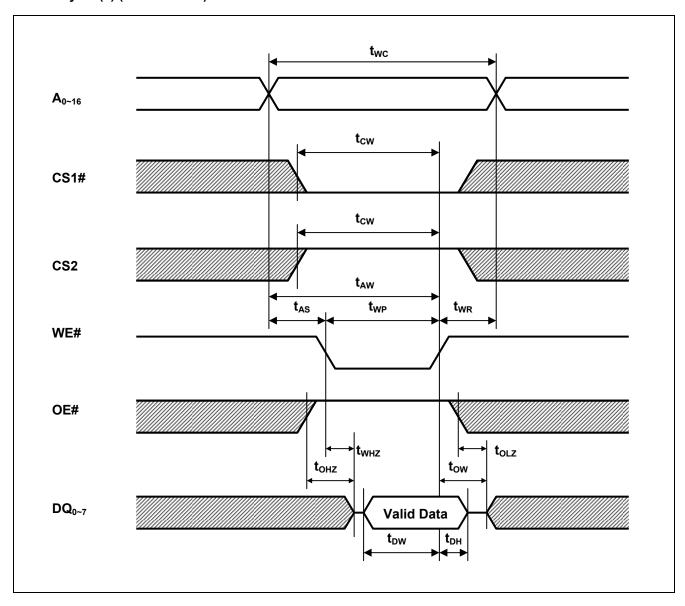
- 1. t_{CHZ} , t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.
- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition, t_{HZ} max is less than t_{LZ} min both for a given device and from device to device.
- 4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE#.
 - A write begins at the latest transition among CS1# going low, CS2 going high and WE# going low.
 - A write ends at the earliest transition among CS1# going high, CS2 going low and WE# going high. t_{WP} is measured from the beginning of write to the end of write.
- 5. t_{CW} is measured from the later of CS1# going low or CS2 going high to end of write.
- 6. t_{AS} is measured the address valid to the beginning of write.
- 7. t_{WR} is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.

Timing Waveforms

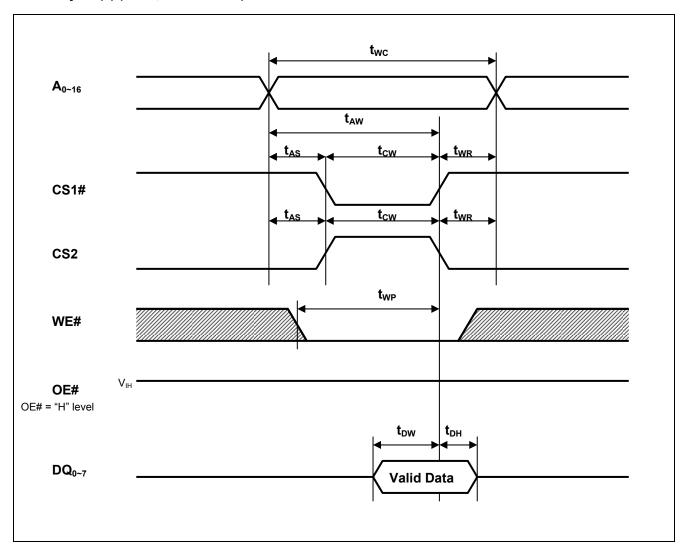
Read Cycle



Write Cycle (1) (WE# CLOCK)



Write Cycle (2) (CS1#, CS2 CLOCK)



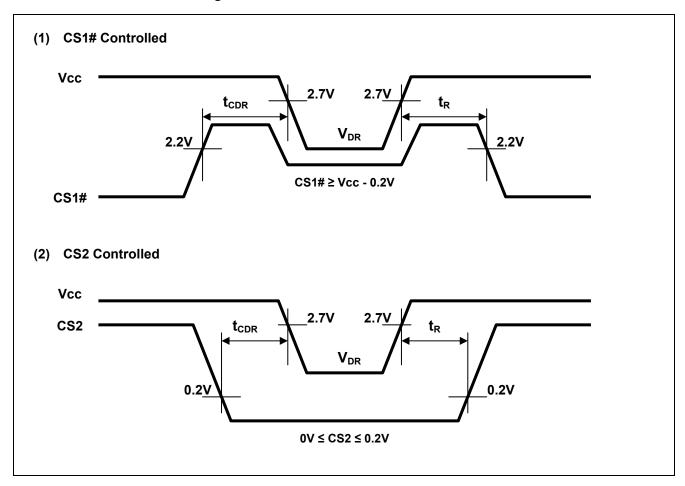
Low Vcc Data Retention Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit		Test conditions*2
V _{CC} for data retention	V_{DR}	2.0	-	3.6	V	(2) CS1#	CS2 ≤ 0.2V or ≥ Vcc-0.2V, √cc-0.2V
		-	0.6*1	2	μА	~+25°C	Vcc=3.0V, Vin ≥ 0V
Data retention current	ICCDR	-	-	3	μА	~+40°C	(1) 0V ≤ CS2 ≤ 0.2V or
Data retention current		-	-	8	μА	~+70°C	(2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V
		-	-	10	μА	~+85°C	
Chip deselect to data retention time	t _{CDR}	0	-	-	ns	Soo roton	tion waveform
Operation recovery time	t _R	5	-	-	ms	See reten	tion waveform.

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

2. CS2 controls address buffer, WE# buffer, CS1# buffer, OE# buffer and Din buffer. If CS2 controls data retention mode, Vin levels (address, WE#, CS1#, OE#, DQ) can be in the high impedance state.
If CS1# controls data retention mode, CS2 must be CS2 ≥ Vcc-0.2V or 0V ≤ CS2 ≤ 0.2V. The other input levels (address, WE#, OE#, DQ) can be in the high impedance state.

Low Vcc Data Retention Timing Waveforms



Revision History	R1LV0108E Series Data Sheet	
------------------	-----------------------------	--

			Description
Rev.	Date	Page	Summary
1.00	2013.6.21	-	First Edition issued

Notice

- 1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information,
- 2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- 3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or
- 4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below

"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.

Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics

- 6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
- 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
- 10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
- 11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries, (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics



SALES OFFICES

Renesas Electronics Corporation

http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information

Renesas Electronics America Inc. 2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Milliboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd. 7th Floor, Quantum Plaza, No.27 ZhiChunLu Ha Tel: +86-10-8235-1155, Fax: +86-10-8235-7679 i. nunLu Haidian District. Beiiing 100083. P.R.China

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2868-9318, Fax: +852 2869-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd. 11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea Tel: 482-2558-3737, Fax: 482-2558-5141

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for SRAM category:

Click to view products by Renesas manufacturer:

Other Similar products are found below:

5962-8855206XA CY6116A-35DMB CY7C128A-45DMB CY7C1461KV33-133AXI CY7C199-45LMB GS8161Z36DD-200I GS88237CB-200I R1QDA7236ABB-20IB0 RMLV0408EGSB-4S2#AA0 IS64WV3216BLL-15CTLA3 IS66WVE4M16ECLL-70BLI PCF8570P K6T4008C1B-GB70 CY7C1353S-100AXC AS6C8016-55BIN AS7C164A-15PCN 515712X IS62WV51216EBLL-45BLI IS63WV1288DBLL-10HLI IS66WVE2M16ECLL-70BLI 47L16-E/SN IS66WVE4M16EALL-70BLI IS62WV6416DBLL-45BLI IS61WV102416DBLL-10TLI CY7C1381KV33-100AXC CY7C1381KV33-100BZXI CY7C1373KV33-100AXC CY7C1381KVE33-133AXI CY7C4042KV13-933FCXC 8602501XA 5962-3829425MUA 5962-8855206YA 5962-8866201XA 5962-8866201YA 5962-8866204TA 5962-8866206MA 5962-8866207NA 5962-8866208UA 5962-8872502XA 5962-8959836MZA 5962-8959841MZA 5962-9062007MXA 5962-9161705MXA N08L63W2AB7I 7130LA100PDG GS81284Z36B-250I M38510/28902BVA 5962-8971203XA 5962-8971202ZA 5962-8872501LA